

257	777	Subclass
257	777	ISSUE CLASSIFICATION

PATENT NUMBER

U.S. UTILITY Patent Application

O.I.P.E.
SCANNED TR4 02/10/03

PATENT DATE

APPLICATION NO. 09/909181	CONT/PRIOR	CLASS 257	SUBCLASS 777	ART UNIT 2815	EXAMINER Cha
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APPLICANTS

Paul Farrar

TITLE

Method of using foamed insulators in three dimensional multichip structures

PTO-2040
12/99

ISSUING CLASSIFICATION

ORIGINAL		CROSS REFERENCE(S)					
CLASS	SUBCLASS	CLASS	SUBCLASS (ONE SUBCLASS PER BLOCK)				
257	777	257	686	701			
INTERNATIONAL CLASSIFICATION		438	108	109			
H01L	23/48	361	760				
H01L	23/52						
H01L	29/40						

☐ Continued on Issue Slip inside File Jacket

<input type="checkbox"/> TERMINAL DISCLAIMER <input type="checkbox"/> The term of this patent subsequent to _____ (date) has been disclaimed. <input type="checkbox"/> The term of this patent shall not extend beyond the expiration date of U.S. Patent No. _____. <input type="checkbox"/> The terminal _____ months of this patent have been disclaimed.	DRAWINGS Sheets Drwg. 4 Figs. Drwg. 5 Print Fig. 5			CLAIMS ALLOWED Total Claims 26 Print Claim for O.G. 1	
	Signature: <i>Amirhabat</i> 7/1/03 (Assistant Examiner) (Date)			NOTICE OF ALLOWANCE MAILED	
	Signature: _____ (Primary Examiner) (Date)			ISSUE FEE Amount Due _____ Date Paid _____	
	Signature: _____ (Legal Instruments Examiner) (Date)			ISSUE BATCH NUMBER	

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